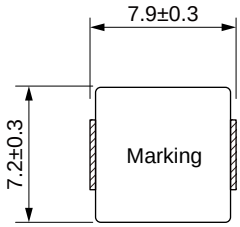
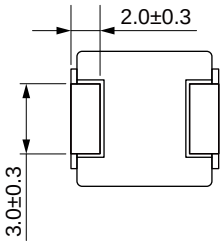
MDA T Series

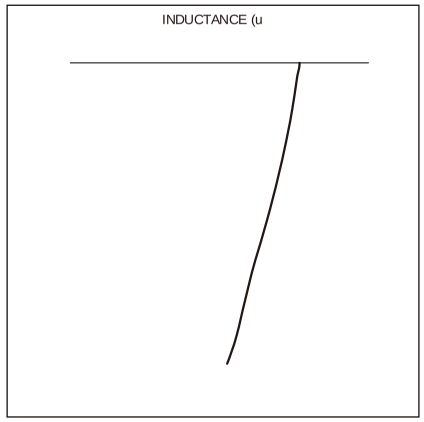
Dimensions: [mm]



Land Pattern: [mm]



Electrical Properties:


INDUCTANCE (u

Soldering Reflow:

Preheat condition: 150 ~200℃/ 60~120 sec.

Allowed time above 217℃: 60~150 sec.

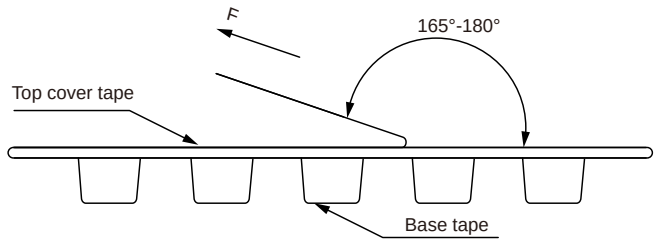
Max temperature: 260℃.

Allowed Reflow time: 2x max.

Packaging Information:

Tape Dimension:

Peel force of top cover tape:

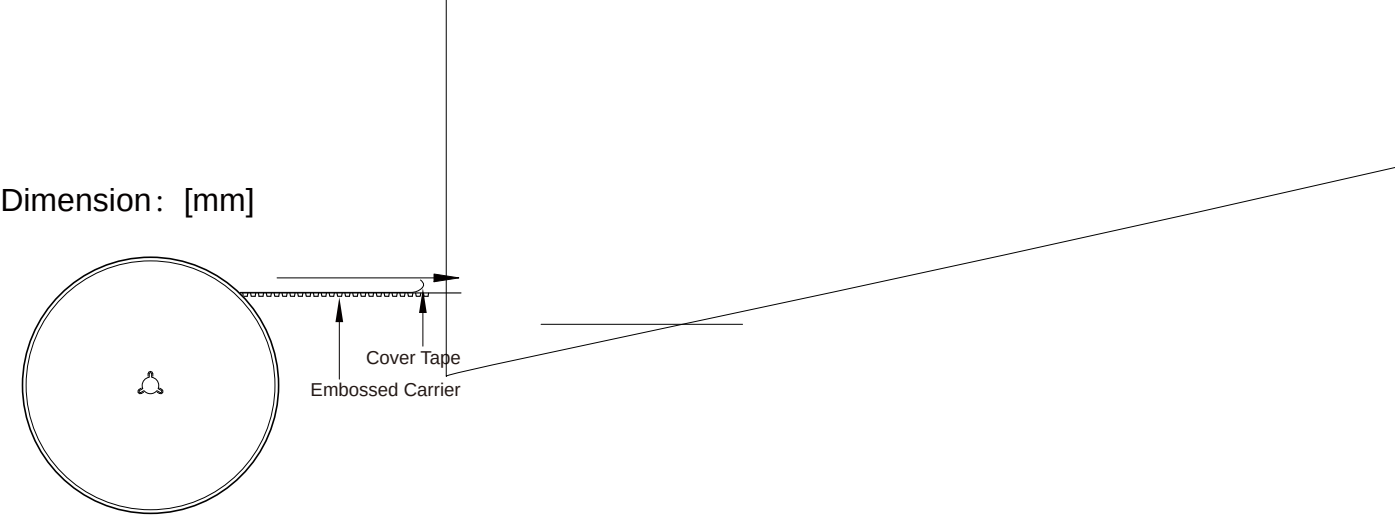


The peel force of top cover tape shall be between 0.1 to 1.3 N

Product Marking:

Marking	K+Printing (Inductance+period)

Reel Dimension：[mm]



Packaging Quantity: